

XRT6164A

Digital Line Interface Transceiver

October 2007

FEATURES

- Single 5V Supply
- Compatible with CCITT G.703 64Kbps Co-Directional Interface Recommendation When Used With Either XRT6165 or XRT6166
- Low Power
- Converts Balanced CMOS Transmit and Receive Signals Propagated Over Two Twisted Pair Cables to TTL Compatible Dual-Rail Data
- Links Remote Equipment Equipped With CCITT G.703 64Kbps Co-Directional Interfaces Over Distances Up to 500 Meters Without Equalization

- Receive Data Comparator Threshold Storage Provides Ping-Pong Operation Capability
- Loss of Signal Alarm
- Dual Matched Driver Outputs

APPLICATIONS

- Data Adaption Unit (DAU)
- General Purpose TTL Compatible Line Interface

GENERAL DESCRIPTION

The XRT6164A is a CMOS analog chip intended for general purpose line interface applications at bit rates up to 1.544Mbps (T1). It contains both receive and transmit circuitry in a 16-pin dual-in-line plastic (PDIP) package. The receiver is designed for short line applications having a cable loss up to 10dB measured at the half bit rate. The transmitter has open collector line driver outputs that are capable of handling up to 40mA. When used in conjunction with either XRT6165 or XRT6166, the chip set provides a 64Kbps codirectional interface as specified in CCITT G.703.

ORDERING INFORMATION

Part No.	Package	Operating Temperature Range	
XRT6164AIP	16-Lead 300 Mil PDIP	-4 0 ° C to +8 5 ° C	
XRT6164AID	16-Lead 300 Mil JEDEC SOIC	-4 0 ° C to +8 5 ° C	



Block Dlagram Positive PEAK CAP Data Comparator S + RRX+I/P TTL Peak Threshold Buffer Detector Generator RX-I/P S-R Neg Dat. Compara. Open Collector Driver Negative Data Comparator TTL Buffer TCM CON Control **RX ALARM** TTL Buffer $V_{CC}A$) I/P BIAS **GNDA** TX+I/P 10) TX + O/P 8 TX - O/P TX-I/P Open Collector Driver $V_{CC}D$ **GNDD**

Figure 1. XRT6164A Block Diagram



PIN CONFIGURATION



16 Lead PDIP (0.300")

16 Lead SOIC (Jedec, 0.300")

PIN DESCRIPTION

Pin#	Symbol	Туре	Description
1	RX-I/P	I	Receiver Negative CMOS Input. Line analog input.
2	I/P BIAS	0	Receive Input Bias. Connects to center tap of input transformer secondary winding.
3	RXALARM	0	Loss of Signal Alarm. Active low:
4	GNDA		Analog Ground.
5	SR	0	Receive Negative Data Output. Output from negative CMOS input pulses (active low).
6	TX-I/P	I	Transmit Negative Input Data. Input for negative output driver (active high).
7	GNDD		Digital Ground.
8	TX-O/P	0	Transmit Negative Output Priver. Open collector, drives output transformer primary.
9	$V_{\infty}D$		+5V +/-5% Digital Supply.
10	TX+O/P	0	Transmit Positive Output Driver. Open collector, drives output transformer primary.
11	TX+I/P	I	Transmit Positive Input Data. Input for positive output driver (active high).
12	S⊮R	0	Receive Positive Data Output. Output from positive CMOS input pulses (active low).
13	V _{cc} A		+5V +/-5% Analog Supply.
14	PEAKCAP		Peak Detector Capacitor. Stores peak detector voltage.
15	TCMCON	I	Time Compression Multiplex Control. When active, disconnects peak detector
charge		100	and discharge paths (active low).
16	RX+I/P	ı	Receiver Positive CMOS Input. Line analog input.

XRT6164A



ELECTRICAL CHARACTERISTICS

Test Conditions: $V_{CC} = 5V + /-5\%$, $T_A = 25^{\circ}C$, Unless Otherwise Specified

Parameters	Min.	Typ.	Max.	Units	
DC Electrical Characteristics		- 71			
Supply Voltage	4.75	5	5.25	V	
Analog Supply Current		7	10	mA	
Digital Supply Current		17	22	mA	
Receiver	<u> </u>				
Input Signal		1	2.2	Vp	Measured from Pins 1 or 16 with Respect to Pin 2
Dynamic Range		-	10	dB	Maximum Cable Loss Range
Input Impedance		20		kΩ	Measured Between Pins 1 and 16
Input Slicing Threshold		50		%	Percent of Peak Input Signal Amplitude
Input Bias Voltage		1.45		V	Measured at Pin 2
Loss of Signal Alarm Threshold		150		mVp	Measured from Pins 1 or 16 with Respect to Pin 2
Loss of Signal Alarm Level		1.5		dB	Difference Between Alarm-on and Alarm-off
Hysteresis					Levels
Peak Detector Leakage		-80		μΑ	Mr. Mr.
Data Output Low			0.4	V	Measured at Pins 5 or 12, I _{OUT} = +1.6mA
Data Output High	3.0			V	Measured at Pins 5 or 12, I _{OUT} = -40μA
Alarm Output Low			0.4	GV.	Measured at Pin 3; I _{OUT} = +1.6mA
Alarm Output High	V _{cc} -		.0	V	Measured at Pin 3; I _{OUT} = -40μA
· -	0.5		70		337
TCM Input Low Voltage			0.8	V V	Measured at Pin 15; I _{IN} Min = -500μA, I _{IN} Max =
			1 10	+5μΑ	
Transmitter			0	10	
Input Low Voltage		9	0.8) V	Measured at Pins 6, 11; $I_{IN} = -700\mu A$
Input High Voltage	2.2		છુ ১	٧	Measured at Pins 6, 11; I _{IN} = +5μA
Output Low Voltage	77)	×	1.2	V	Measured at Pins 8, 10; I _{OUT} = -40mA
Output Low Current	S	S	40	mA	Measured at Pins 8, 10; V _{OUT} = 1V
Output Leakage Current	-100		•	μΑ	Measured at Pins 8, 10; V _{OUT} = 10V Outputs in
Q.	(5	2			off state
AC Electrical Characteristics					
Receiver	0 0				
Input Level		1	2.2	Vp	Pin 1, 16 with Respect to Pin 2 1
Output Rise Time	•		80	ns	Pins 5, 12; C L = 15pF, 10% to 90%
Output Fall Time			80	ns	Pins 5, 12; C L =15pF, 90% to 10%

Notes:

Bold face parameters are covered by production test and guaranteed over operating temperature range.

^{1.} Higher input voltages are possible if a resistive input attenuator is used.

EX4R

XRT6164A

ELECTRICAL CHARACTERISTIC (CONT'D)

Parameters	Min.	Тур.	Max.	Units	Conditions
AC Electrical Characteristics (Cont'd)					
Transmitter					
Output Rise Time			80	ns	Pins 8, 10; $R_L = 130$, $C_L = 15pF$, 10% to 90%
Output Fall Time			80	ns	Pins 8, 10; R _L = 130, C _L = 15pF, 90% to 10%
Rising Edge Delay			100	ns	Pins 8, 10; $R_L = 130$, $C_L = 15pF$, 50% to 50%
					(I/P to O/P)
Falling Edge Delay			100	n s	Pins 8, 10; R _L = 130, C _L = 15pF, 50% to 50%
					(I/P to O/P)

Notes:

Bold face parameters are covered by production test and guaranteed over operating temperature range. Specifications are subject to change without notice

ABSOLUTE MAXIMUM RATINGS

Supply Voltage 20V Storage Temperature-65°C to +150°C

Magnetic Supplier Information:

Pulse Telecom Product Group P.O. Box 12235 San Diego, CA 92112 Tel. (619) 674-8100 Fax. (619) 674-8262

Transpower Tech.
24 Highway 28, St.
Crystal Bay, NV 89
Tel. (702) 831-0140
Fax. (702) 831-3521 Transpower Technologies, Inc. 24 Highway 28, Suite 202 Crystal Bay, NV 89402-0187

XRT6164A



SYSTEMDESCRIPTION

The XRT6164A is a general purpose line interface chip that contains the receive and transmit circuitry necessary to convert TTL logic levels to a CMOS signal both to and from a twisted pair cable.

Receiver

The XRT6164A receiver section converts a balanced CMOS signal that has been attenuated and distorted by up to 10dB of twisted pair cable to active-low TTL-compatible logic levels.

The cable is transformer coupled to the receiver differential inputs (RX+IP, RX-IP) which are biased through the input transformer secondary winding by a voltage generated on-chip (I/PBIAS). The CMOS receive signal is applied to a peak detector, and to a pair of data comparators. The peak detector output voltage charges an external capacitor connected to PEAK CAP. This voltage generates a data comparator bias level that is approximately 50% of the peak input pulse amplitude.

Thus, data slicing is automatically accomplished at the optimum level over the full cable loss range. TL-compatible output stages buffer the receiver digital outputs (S+R, S-R) and provide active low signals corresponding to received positive and negative input pulses.

Loss of input signal is detected by a comparator that monitors input signal level. An active-low TL-compatible logic level (RX ALARM) indicates signal loss. Comparator hysteresis prevents chatter on this output. Ping-pong operation is made possible by the time compression multiplex control input (TCM CON). A logic 0 applied to this pin during transmission stores the peak detector output voltage by disconnecting the peak detector storage capacitor charge and discharge paths.

Since the receive data comparator bias voltage is stored during transmit mode, it is immediately available when receive mode resumes.

Transmitter

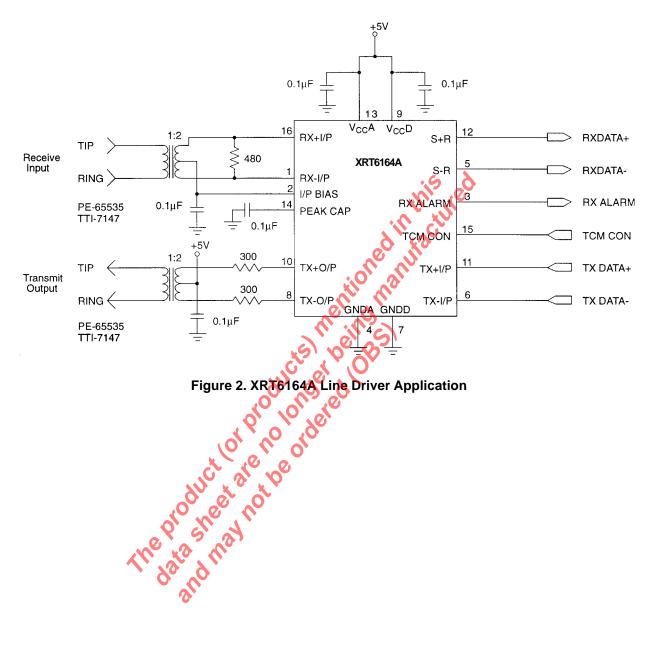
The XRT6164A transmitter section contains two matched open collector output drivers that are capable of driving the line transformer directly with a current up to 40mA. The transmitter output drivers include diode clamps to ensure non-saturating operation. Transmitter digital inputs, which are active-low, are TTL-compatible. External resistors are used between the transmitter outputs and the output transformer primary to set the output pulse amplitude.

APPLICATION INFORMATION

Figure 2 shows a general line driver application circuit using the XRT6164A. This device converts CMOS transmit and receive signals in the 64Kbps to 1.544Mbps range to active-low TTL-compatible logic levels. CMOS signals that have been attenuated and distorted by twisted pair cable are transformer-coupled to the line side of the XRT6164A as shown on the left side of Figure 2. Suggested transformers for both the input and output applications are the Pulse types PE-65535 or TTI-7147 for 64Kbps use and the PE-65835 for 1.544Mbps applications.

The right side of *Figure 2* shows the TTL-compatible digital inputs and outputs. Please refer to the pin description section of this data sheet for detailed information about each signal.

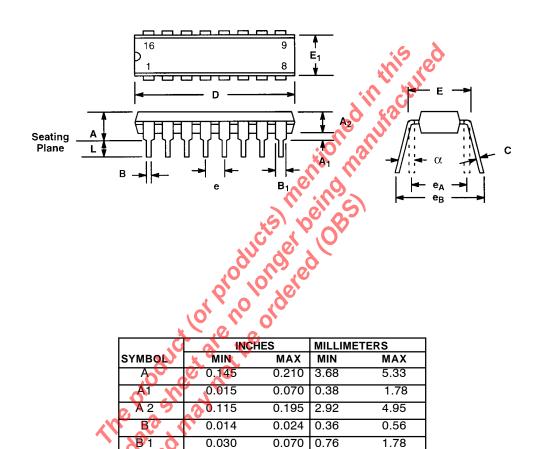






16 LEAD PLASTIC DUAL-IN-LINE (300 MIL PDIP)

Rev. 1.00



0.014

0.840

0.325

0.280

0.430

0.160

15°

0.20

18.92

7.62

6.10

7.87

2.92

0°

0.38

21.34

8.26

7.11

10.92

4.06

15°

2.54 BSC

7.62 BSC

Note: The control dimension is the inch column

0.008

0.745

0.300

0.240

0.310

0.115

0°

0.100 BSC

0.300 BSC

C

D

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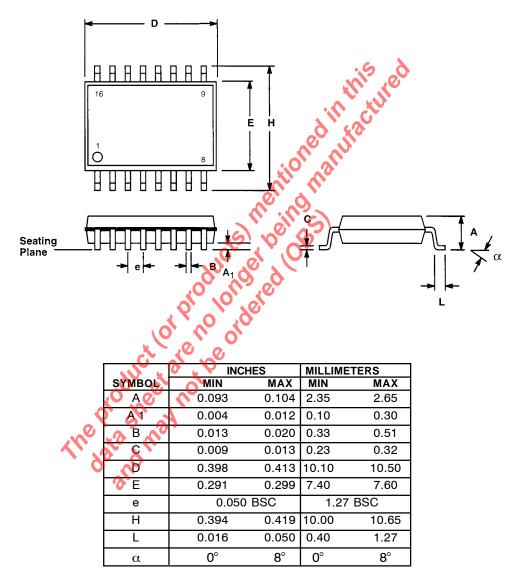
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16 LEAD SMALL OUTLINE (300 MIL JEDEC SOIC)

Rev. 1.00



Note: The control dimension is the millimeter column



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